

**50V Low Current Consumption  
150mA CMOS Voltage Regulator**

**LR6675 Series**

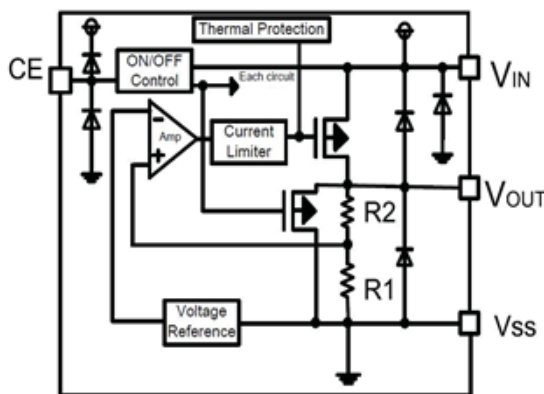
**■ INTRODUCTION**

The LR6675 series are a group of positive voltage regulators manufactured by CMOS technologies with low power consumption and low dropout voltage, which provide large output currents even when the difference of the input-output voltage is small. The LR6675 series can deliver 150mA output current and allow an input voltage as high as 60V. The series are very suitable for the battery-powered equipments, such as RF applications and other systems requiring a quiet voltage source.

**■ APPLICATIONS**

- Cordless Phones
- Radio control systems
- Laptop, Palmtops and PDAs
- Single-lens reflex DSC
- PC peripherals with memory

**■ BLOCK DIAGRAM**



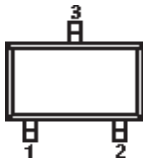
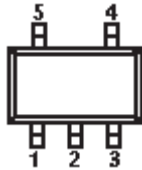
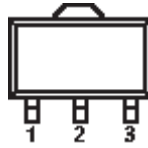
**■ FEATURES**

- Low Quiescent Current: 3μA
  - Operating Voltage Range: 2.5V~50V
  - Output Current: 150mA
  - Low Dropout Voltage:  
500mV@50mA(V<sub>OUT</sub>=3.3V)
  - Output Voltage: 1.2~12.0V
  - High Accuracy: ±2%/±1% (Typ.)
  - High Power Supply Rejection Ratio:  
80dB@1kHz
  - Low Output Noise:  
27xV<sub>OUT</sub> μV<sub>RMS</sub> (10Hz~100kHz)
  - Excellent Line and Load Transient Response
  - Built-in Current Limiter, Short-Circuit Protection
  - Over-Temperature Protection
- 
- Wireless Communication Equipments
  - Portable Audio Video Equipments
  - Car Navigation Systems
  - LAN Cards
  - Ultra Low Power Microcontroller

**■ ORDER INFORMATION**

**LR6675①②③④**

DESIGNATOR	SYMBOL	DESCRIPTION
①	A	Without EN
	B	With Shutdown Function
②	Integer	Output Voltage e.g. 3.3V=33 e.g. 12.0V=120
③	M/ MC/ MY	Package: SOT-23-3/5
	P/PT/PL	Package: SOT-89-3
④		2% Accuracy
	1	1% Accuracy

**■ PIN CONFIGURATION**
**SOT-23-3**

**SOT-23-5**

**SOT-89-3**

**LR6675A**

PIN NUMBER						PIN NAME	FUNCTION
SOT-23-3			SOT-89-3				
M	MC	MY	P	PT	PL		
1	3	3	1	2	2	V <sub>SS</sub>	Ground
2	2	1	3	1	3	V <sub>OUT</sub>	Output
3	1	2	2	3	1	V <sub>IN</sub>	Power input

**LR6675B**
**SOT-23-5**

PIN NUMBER	SYMBOL	FUNCTION
1	V <sub>IN</sub>	Power Input Pin
2	V <sub>SS</sub>	Ground
3	CE	Chip Enable Pin
4	NC	No Connection
5	V <sub>OUT</sub>	Output Pin

■ ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

(Unless otherwise specified, T<sub>A</sub>=25°C)

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage <sup>(2)</sup>		V <sub>IN</sub>	-0.3~65	V
Output Voltage <sup>(2)</sup>		V <sub>OUT</sub>	-0.3~15	V
CE Pin Voltage <sup>(2)</sup>		V <sub>CE</sub>	-0.3~V <sub>IN</sub> +0.3	V
Output Current		I <sub>OUT</sub>	400	mA
Power Dissipation	SOT-23	P <sub>D</sub>	0.4	W
	SOT-89		0.6	W
Operating Junction Temperature Range		T <sub>j</sub>	-40~125	°C
Storage Temperature		T <sub>stg</sub>	-40~125	°C
Lead Temperature(Soldering, 10 sec)		T <sub>solder</sub>	260	°C
ESD rating <sup>(3)</sup>		Human Body Model-(HBM)	2	kV
		Machine Model- (MM)	200	V

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to network ground terminal.

(3) ESD testing is performed according to the respective JEDEC standard.

The human body model is a 100 pF capacitor discharged through a 1.5kΩ resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

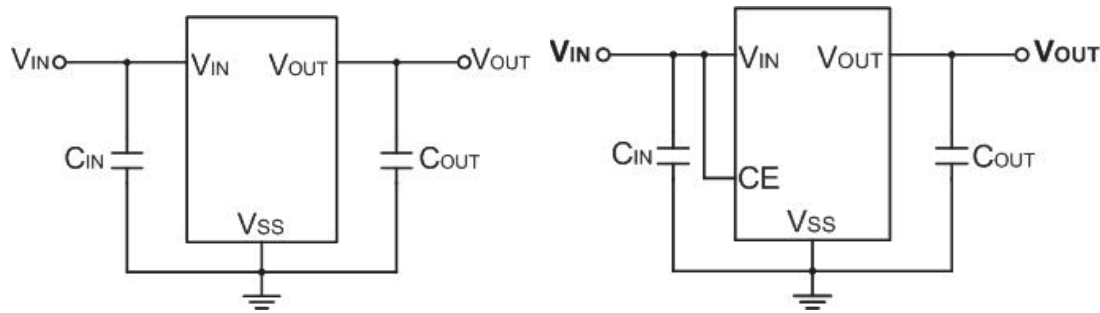
■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	MIN.	NOM.	MAX.	UNITS
Supply voltage at V <sub>IN</sub>	2.5		50	V
Operating junction temperature range, T <sub>j</sub>	-40		125	°C
Operating free air temperature range, T <sub>A</sub>	-40		85	°C

**■ ELECTRICAL CHARACTERISTICS**
**LR6675 Series ( $V_{CE}=V_{IN}=V_{OUT}+2V$ ,  $C_{IN}=C_{OUT}=1\mu F$ ,  $T_A=25^\circ C$ , unless otherwise specified)**

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP. <sup>(4)</sup>	MAX.	UNITS	
Input Voltage	$V_{IN}$		2.5	—	50	V	
Output Voltage Range	$V_{OUT}$		1.2	—	12	V	
DC Output Accuracy		$I_{OUT}=1mA$	-2	—	2	%	
			-1	—	1	%	
Dropout Voltage	$V_{dif}^{(5)}$	$I_{OUT}=50mA, V_{OUT}=3.3V$	—	500	—	mV	
Supply Current	$I_{SS}$	$I_{OUT}=0A$	$V_{OUT}\leq 5.0V$	—	3	$\mu A$	
			$V_{OUT}>5.0V$	—	5	10	$\mu A$
Standby Current	$I_{STBY}$	$CE = V_{SS}$	—	0.1	0.5	$\mu A$	
Line Regulation	$\frac{\Delta V_{OUT}}{V_{OUT} \times \Delta V_{IN}}$	$I_{OUT}=10mA$ $V_{OUT}+1V \leq V_{IN} \leq 18V$	—	0.01	0.3	%/V	
Load Regulation	$\underline{\Delta} V_{OUT}$	$V_{IN}=V_{OUT}+1V$ , $1mA \leq I_{OUT} \leq 100mA$	—	10	—	mV	
Temperature Coefficient	$\frac{\Delta V_{OUT}}{V_{OUT} \times \Delta T_A}$	$I_{OUT}=10mA$ , $-40^\circ C < T_A < 125^\circ C$	—	50	—	ppm	
Output Current Limit	$I_{LIM}$	$V_{OUT}=0.5 \times V_{OUT(Normal)}$ , $V_{IN}=5V$	150	250	—	mA	
Short Current	$I_{SHORT}$	$V_{OUT}=V_{SS}$	—	20	—	mA	
Power Supply Rejection Ratio	PSRR	$I_{OUT}=50mA$	100Hz	—	75	—	dB
			1kHz	—	80	—	
			10kHz	—	60	—	
			100kHz	—	45	—	
Output Noise Voltage	$V_{ON}$	BW=10Hz to 100kHz	—	$27 \times V_{OUT}$	—	$\mu V_{RMS}$	
Thermal Shutdown Temperature	$T_{SD}$	—	—	170	—	$^\circ C$	
Thermal Shutdown Hysteresis	$\Delta T_{SD}$	—	—	20	—	$^\circ C$	
CE "High" Voltage	$V_{CE"H"}$		1.5	—	$V_{IN}$	V	
CE "Low" Voltage	$V_{CE"L"}$		—	—	0.3	V	

■ TYPICAL APPLICATION CIRCUIT



External Components List

Symbol	Description
C <sub>IN</sub>	1.0μF or more
C <sub>OUT</sub>	1.0μF or more, 10μF is recommended

■ APPLICATION INFORMATION

■ Selection of Input/ Output Capacitors

Phase compensation is provided to secure operation even when the load current is varied. For this purpose, use a 1.0μF or more output capacitor (C<sub>OUT</sub>) with good frequency characteristics and proper ESR (Equivalent Series Resistance). Connect a 1.0μF or more input capacitor (C<sub>IN</sub>) between the V<sub>IN</sub> pin and the V<sub>SS</sub> pin as close as possible to the pins. The value of the output overshoot or undershoot transient response varies depending on the value of the output capacitor.

When selecting the output capacitor, perform sufficient evaluation, including evaluation of temperature characteristics, on the actual device.

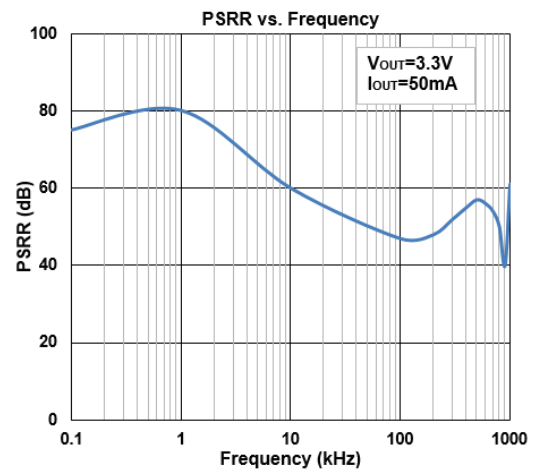
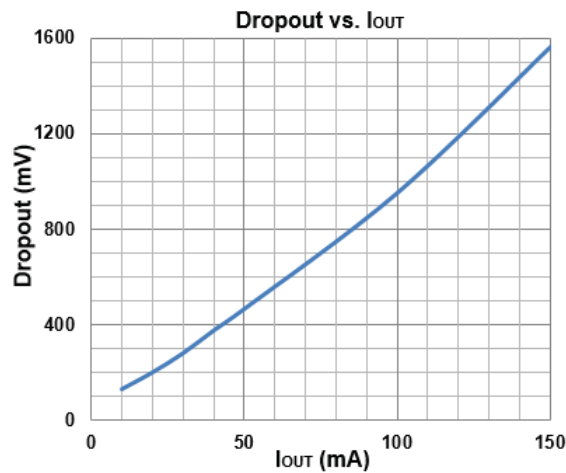
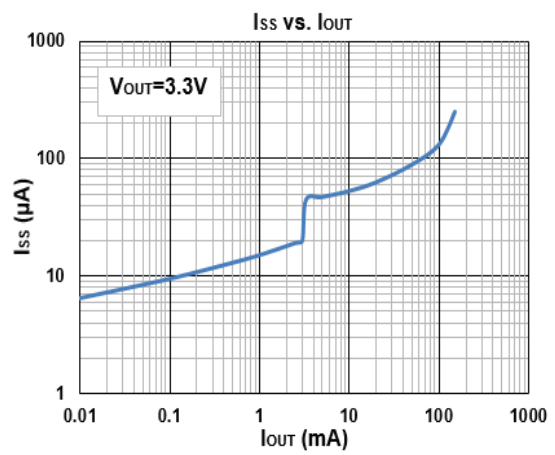
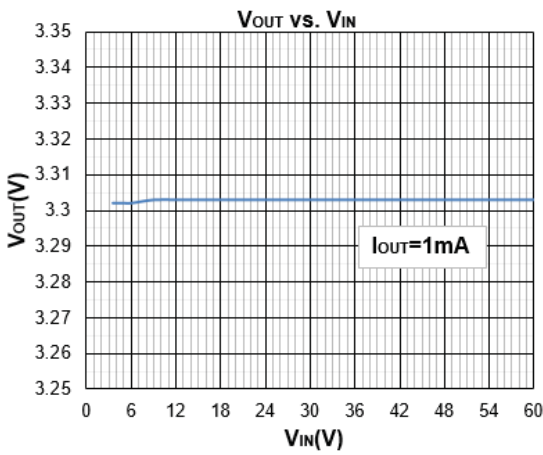
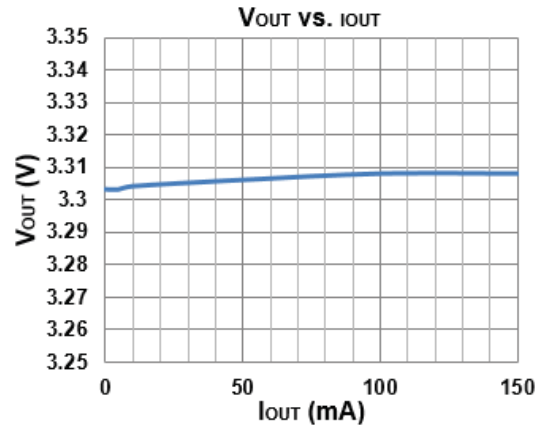
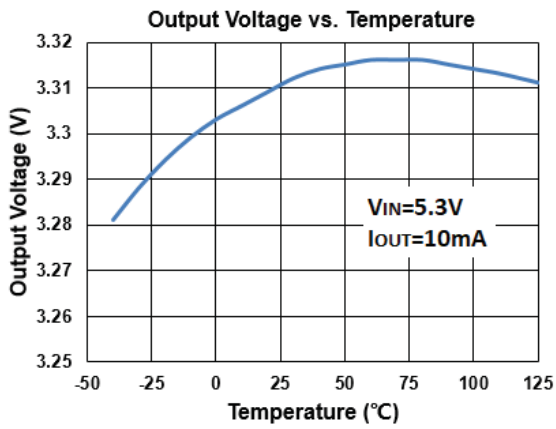
In the design of portable devices the ceramic capacitors are often chosen because of their small size, low equivalent series resistance (ESR) and high RMS current capability. Also, designers have been looking to ceramic capacitors due to shortages of tantalum capacitors.

Unfortunately, using ceramic capacitors for input filtering can cause problems. Applying a voltage step to a ceramic capacitor causes a large current surge that stores energy in the inductances of the power leads. A large voltage spike is created when the stored energy is transferred from these inductances into the ceramic capacitor. These voltage spikes can easily be twice the amplitude of the input voltage step.

Many types of capacitors can be used for input bypassing, however, caution must be exercised when using multilayer ceramic capacitors (MLCC). Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the LDO input to a live power source. Adding a 3Ω resistor in series with an X5R ceramic capacitor will minimize start-up voltage transients.

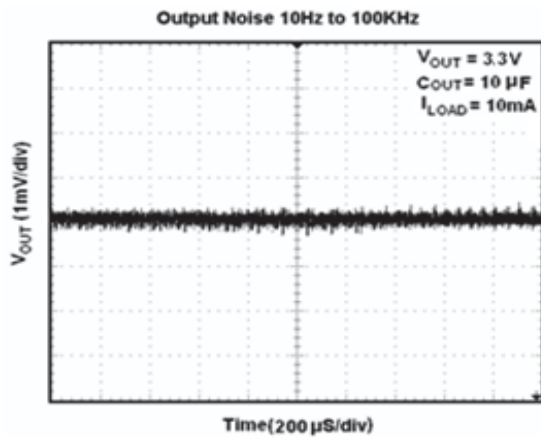
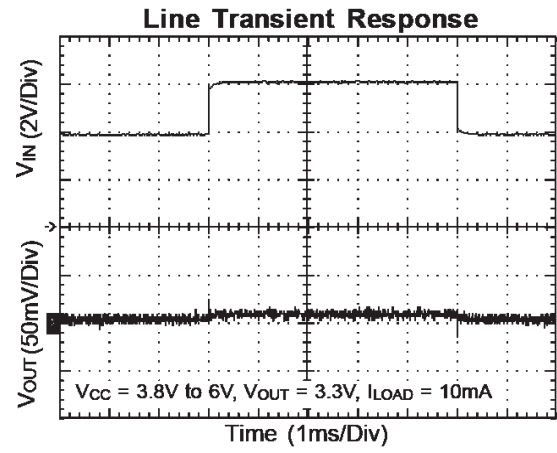
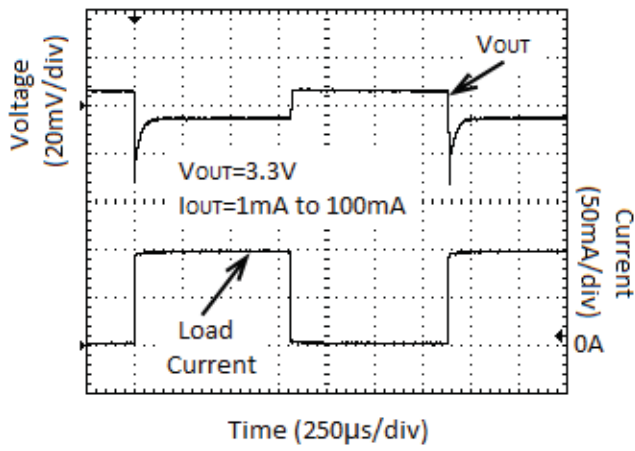
■ TYPICAL PERFORMANCE CHARACTERISTICS

( $V_{CE}=V_{IN}=V_{OUT}+2V$ ,  $C_{IN}=1\mu F$ ,  $C_{OUT}=10\mu F$ ,  $T_A=25^\circ C$ , unless otherwise specified)



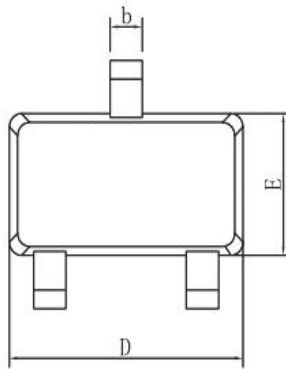
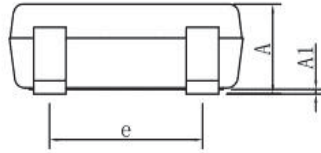
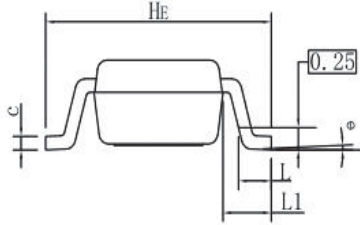
**■ TYPICAL PERFORMANCE CHARACTERISTICS**

( $V_{CE}=V_{IN}=V_{OUT}+2V$ ,  $C_{IN}=1\mu F$ ,  $C_{OUT}=10\mu F$ ,  $T_A=25^\circ C$ , unless otherwise specified)



■ PACKAGING INFORMATION

● SOT-23-3 PACKAGE OUTLINE DIMENSIONS

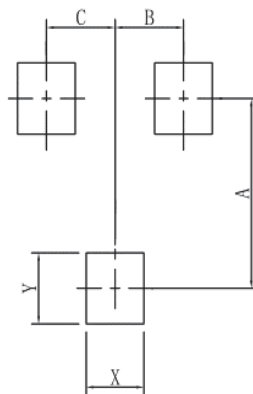


DIM	MIN	NOR	MAX
A	0.90	1.00	1.10
A1	0.01	0.06	0.10
b	0.30	0.40	0.50
c	0.10	0.17	0.20
D	2.80	2.90	3.00
E	1.50	1.60	1.70
e	1.80	1.90	2.00
L	0.20	0.40	0.60
L1	0.60REF		
HE	2.60	2.80	3.00
θ	0°	-	10°
All Dimensions in mm			

GENERAL NOTES

- 1.Top package surface finish Ra0.4±0.2um
- 2.Bottom package surface finish Ra0.7±0.2um
- 3.Side package surface finish Ra0.4±0.2um

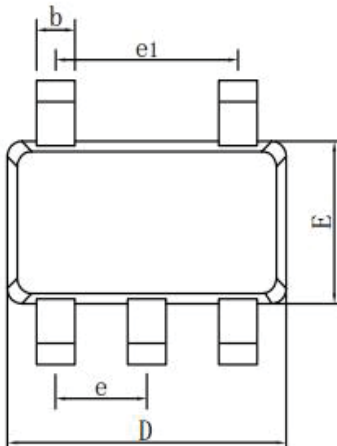
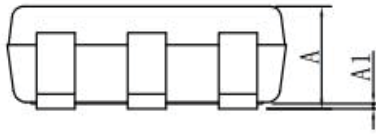
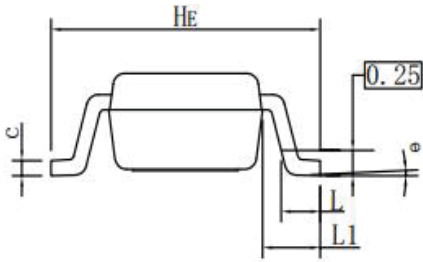
SOLDERING FOOTPRINT



DIM	(mm)
X	0.80
Y	0.90
A	2.40
B	0.95
C	0.95



● SOT-23-5 PACKAGE OUTLINE DIMENSIONS

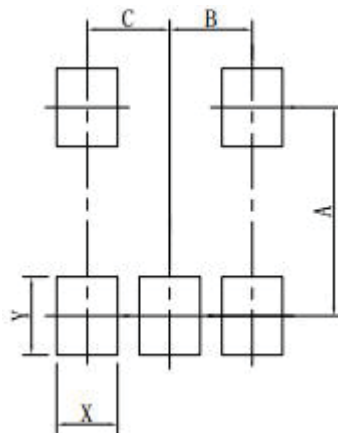


DIM	MIN	NOR	MAX
A	0.90	1.00	1.10
A1	0.01	0.06	0.10
b	0.30	0.40	0.50
c	0.10	0.17	0.20
D	2.80	2.90	3.00
E	1.50	1.60	1.70
e	0.85	0.95	1.05
e1	1.80	1.90	2.00
L	0.20	0.40	0.60
L1	0.60REF		
HE	2.60	2.80	3.00
θ	0°	-	10°

GENERAL NOTES

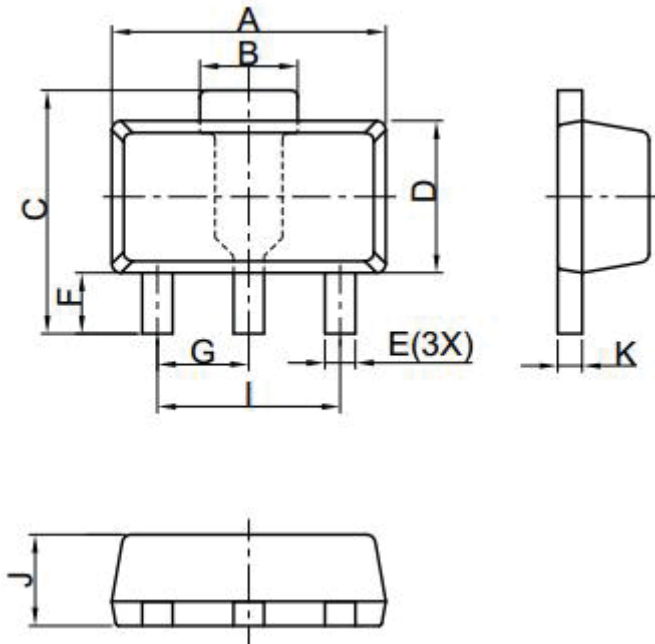
- 1.Top package surface finish Ra0.4±0.2um
- 2.Bottom package surface finish Ra0.7±0.2um
- 3.Side package surface finish Ra0.4±0.2um

SOLDERING FOOTPRINT



DIM	(mm)
X	0.70
Y	0.90
A	2.40
B	0.95
C	0.95

● SOT-89-3 PACKAGE OUTLINE DIMENSIONS

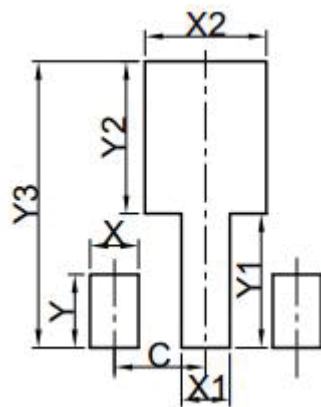


DIM	MIN	NOR	MAX
A	4.40	4.50	4.60
B	1.40	1.60	1.80
C	3.90	4.00	4.25
D	2.40	2.50	2.60
E	0.40	0.50	0.58
F	0.90	1.00	1.20
G	1.50 BSC		
I	3.00 BSC		
J	1.40	1.50	1.60
K	0.34	0.40	0.50
All Dimensions in mm			

GENERAL NOTES

1. Top package surface finish Ra0.4±0.2um
2. Bottom package surface finish Ra0.7±0.2um
3. Side package surface finish Ra0.4±0.2um per side.

SOLDERING FOOTPRINT



DIM	(mm)
X	0.80
Y	1.20
X1	0.80
Y1	2.20
X2	2.00
Y2	2.50
C	1.50
Y3	4.70

■ ORDER INFORMATION APPENDIX

Device <sup>(4)</sup>	Output Voltage <sup>(5)</sup>	Package	Marking <sup>(6)(7)</sup>	Shipping
LR6675AxxM	1.2V~12V	SOT-23-3	AAX	3K/Reel
LR6675AxxMC	1.2V~12V	SOT-23-3	ACX	3K/Reel
LR6675AxxMY	1.2V~12V	SOT-23-3	AYX	3K/Reel
LR6675BxxM	1.2V~12V	SOT-23-5	ABX	3K/Reel
LR6675AxxP	1.2V~12V	SOT-89-3	ADX	1K/Reel
LR6675AxxPL	1.2V~12V	SOT-89-3	ALX	1K/Reel
LR6675AxxPT	1.2V~12V	SOT-89-3	ATX	1K/Reel
LR6675AxxP1	1.2V~12V	SOT-89-3	AZX	1K/Reel
LR6675AxxPT1	1.2V~12V	SOT-89-3	AWX	1K/Reel

(4) : "xx" represents output voltage, eg "18" express that the output voltage is 1.8V

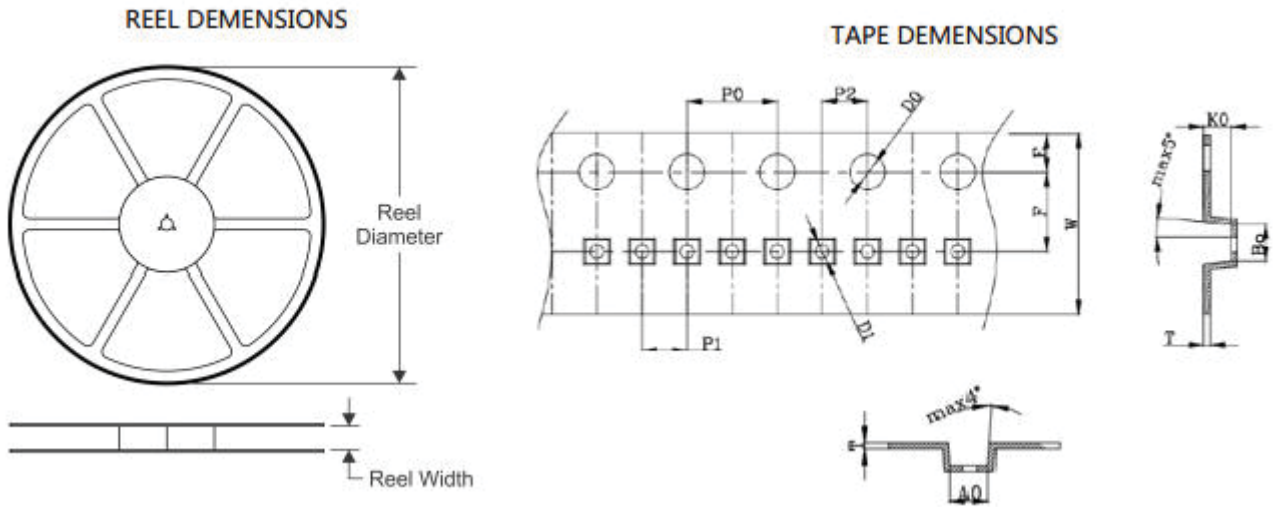
(5) : Output voltage varies from 1.2V to 12V, 0.1V an interval

(6) : The last letter "X" changes along with the output voltage, as figure below

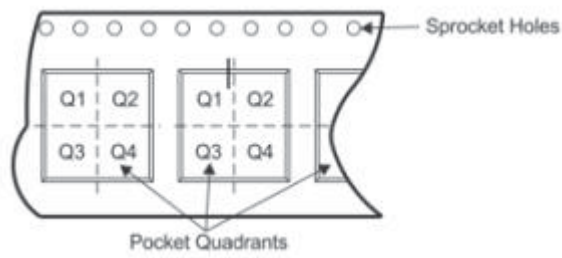
(7) : There are additional marking, which relates to the date code

Voltage	....	1.0	1.2	1.5	1.8	2.5	2.7	2.8	3.0	3.3	3.6	4.0	4.2	5.0	....
Symble	....	D	E	F	G	H	I	J	K	L	M	N	T	P	....

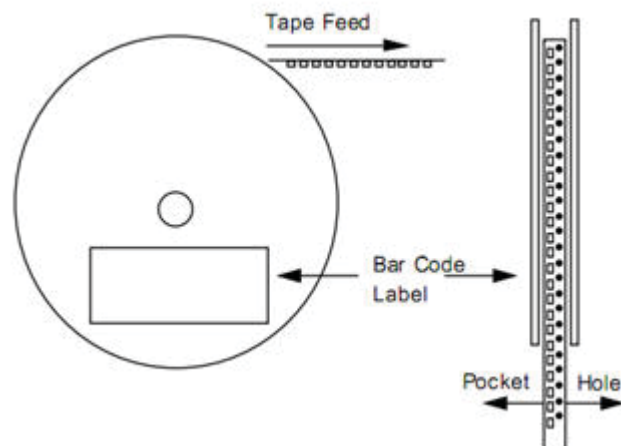
■ TAPE AND REEL INFORMATION



PIN ORIENTATION



ROLLING ORIENTATION



Device	Package	Reel Diameter (mm)	Reel width (mm)	P0 (mm)	P1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	W (mm)	PIN1
LR6675AxxM	SOT-23-3	178±1	9.6±1.2	4.00±0.1	4.00±0.1	3.1±0.1	3.28±0.1	1.32±0.1	8.0±0.1	NA
LR6675AxxMC	SOT-23-3	178±1	9.6±1.2	4.00±0.1	4.00±0.1	3.1±0.1	3.28±0.1	1.32±0.1	8.0±0.1	NA
LR6675AxxMY	SOT-23-3	178±1	9.6±1.2	4.00±0.1	4.00±0.1	3.1±0.1	3.28±0.1	1.32±0.1	8.0±0.1	NA
LR6675BxxM	SOT-23-5	178±1	9.6±1.2	4.00±0.1	8.00±0.1	4.75±0.1	4.2±0.1	1.75±0.1	12.0 <sup>+0.3</sup> <sub>-0.1</sub>	Q3
LR6675AxxP	SOT-89-3	178±1	13.0 <sup>+1</sup> <sub>-0.5</sub>	4.00±0.1	8.00±0.1	4.75±0.1	4.2±0.1	1.75±0.1	12.0 <sup>+0.3</sup> <sub>-0.1</sub>	NA
LR6675AxxPT	SOT-89-3	178±1	13.0 <sup>+1</sup> <sub>-0.5</sub>	4.00±0.1	8.00±0.1	4.75±0.1	4.2±0.1	1.75±0.1	12.0 <sup>+0.3</sup> <sub>-0.1</sub>	NA
LR6675AxxPL	SOT-89-3	178±1	13.0 <sup>+1</sup> <sub>-0.5</sub>	4.00±0.1	8.00±0.1	4.75±0.1	4.2±0.1	1.75±0.1	12.0 <sup>+0.3</sup> <sub>-0.1</sub>	NA

单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)